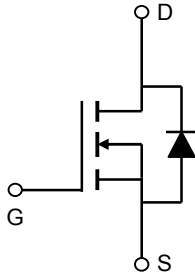
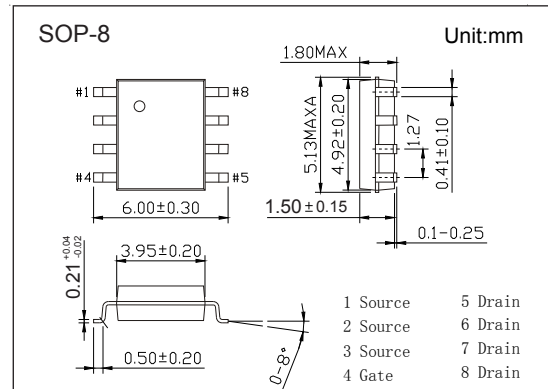


N-Channel MOSFET

AO4484-HF (KO4484-HF)

■ Features

- $V_{DS} (V) = 40V$
- $I_D = 10 A (V_{GS} = 10V)$
- $R_{DS(ON)} < 10m\Omega (V_{GS} = 10V)$
- $R_{DS(ON)} < 12m\Omega (V_{GS} = 4.5V)$
- Pb-Free Package May be Available. The G-Suffix Denotes a Pb-Free Lead Finish



■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter		Symbol	10 Sec	Steady State	Unit
Drain-Source Voltage		V_{DS}	40		V
Gate-Source Voltage		V_{GS}	± 20		
Continuous Drain Current	$T_A=25^\circ C$	I_D	13.5	10	A
	$T_A=70^\circ C$		10.8	8	
Pulsed Drain Current		I_{DM}	120		
Avalanche Current		I_{AR}	23		
Repetitive Avalanche Energy	$L=0.3mH$	E_{AR}	79		mJ
Power Dissipation	$T_A=25^\circ C$	P_D	3.1	2.7	W
	$T_A=70^\circ C$		2	1.1	
Thermal Resistance.Junction- to-Ambient		R_{thJA}	40	75	$^\circ C/W$
Thermal Resistance.Junction- to-Lead		R_{thJL}	-	24	
Junction Temperature		T_J	150		$^\circ C$
Storage Temperature Range		T_{stg}	-55 to 150		

N-Channel MOSFET

AO4484-HF (KO4484-HF)

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit	
Drain-Source Breakdown Voltage	V _{DSS}	I _D =250 μA, V _{GS} =0V	40			V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V, V _{GS} =0V			1	μA	
		V _{DS} =40V, V _{GS} =0V, T _J =55°C			5		
Gate-Body Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1.7		3	V	
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =10A			10	mΩ	
		V _{GS} =10V, I _D =10A, T _J =125°C			16		
		V _{GS} =4.5V, I _D =8A			12.5		
On State Drain Current	I _{D(ON)}	V _{GS} =10V, V _{DS} =5V	120			A	
Forward Transconductance	g _{FS}	V _{DS} =5V, I _D =10A		75		S	
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =20V, f=1MHz		1500	1950	pF	
Output Capacitance	C _{oss}			215			
Reverse Transfer Capacitance	C _{rss}			135			
Gate Resistance	R _g	V _{GS} =0V, V _{DS} =0V, f=1MHz	2		5	Ω	
Total Gate Charge (10V)	Q _g	V _{GS} =10V, V _{DS} =20V, I _D =10A		27.2	37	nC	
Total Gate Charge (4.5V)				13.6	18		
Gate Source Charge			Q _{gs}		4.5		
Gate Drain Charge			Q _{gd}		6.4		
Turn-On DelayTime	t _{d(on)}	V _{GS} =10V, V _{DS} =20V, R _L =2Ω, R _{GEN} =3Ω		6.4		ns	
Turn-On Rise Time	t _r			17.2			
Turn-Off DelayTime	t _{d(off)}			29.6			
Turn-Off Fall Time	t _f			16.8			
Body Diode Reverse Recovery Time	t _{rr}	I _F = 10A, di/dt= 100A/us		30	40	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			19			
Maximum Body-Diode Continuous Current	I _S				2.5	A	
Diode Forward Voltage	V _{SD}	I _S =1A, V _{GS} =0V			1	V	

Note : The static characteristics in Figures 1 to 6 are obtained using <300 us pulses, duty cycle 0.5% max.

■ Marking

Marking	4484
	KC**** _F

N-Channel MOSFET AO4484-HF (KO4484-HF)

■ Typical Characteristics

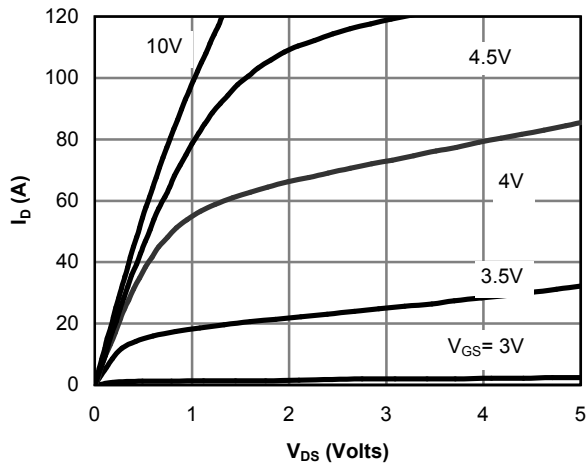


Figure 1: On-Region Characteristics

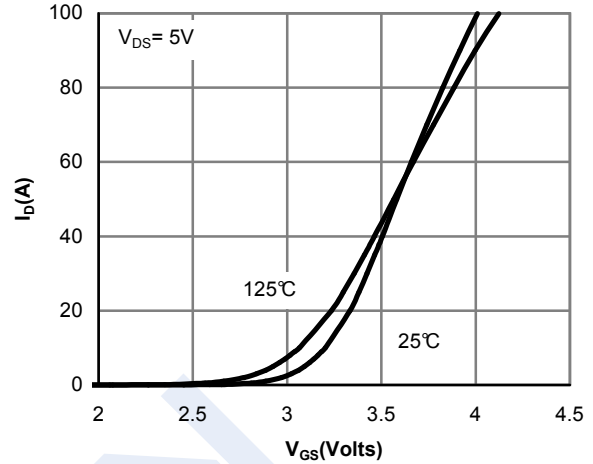


Figure 2: Transfer Characteristics

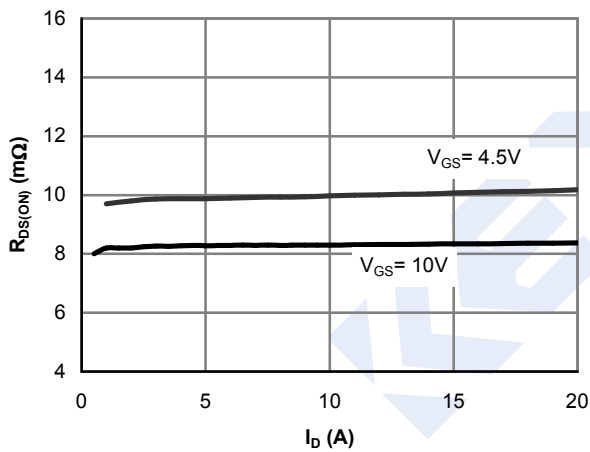


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

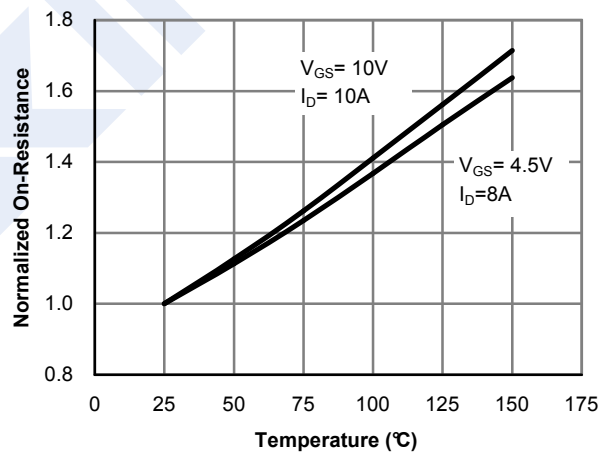


Figure 4: On-Resistance vs. Junction Temperature

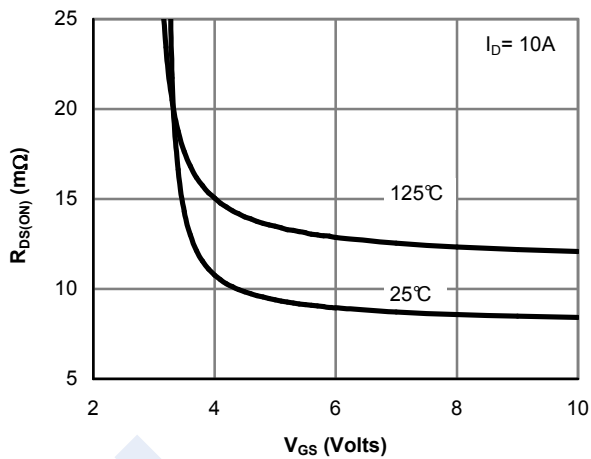


Figure 5: On-Resistance vs. Gate-Source Voltage

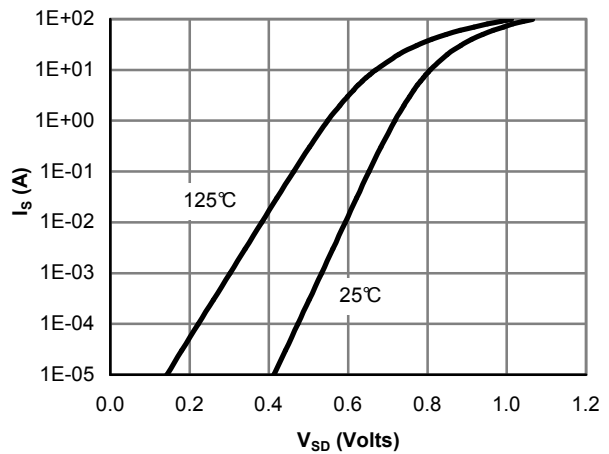


Figure 6: Body-Diode Characteristics

N-Channel MOSFET AO4484-HF (KO4484-HF)

■ Typical Characteristics

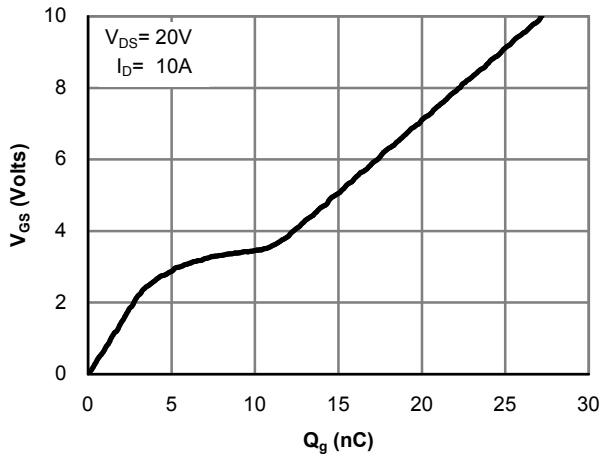


Figure 7: Gate-Charge Characteristics

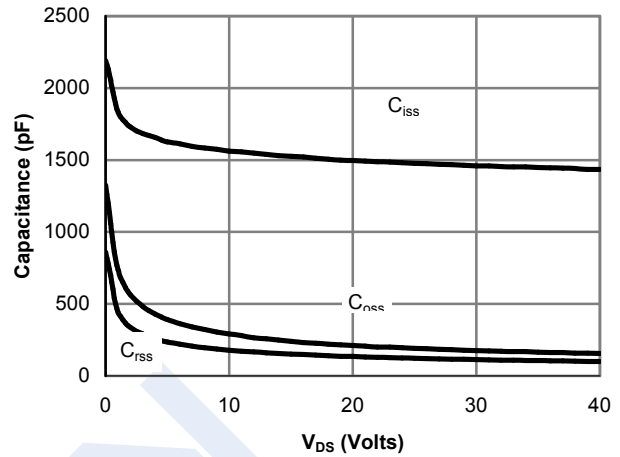


Figure 8: Capacitance Characteristics

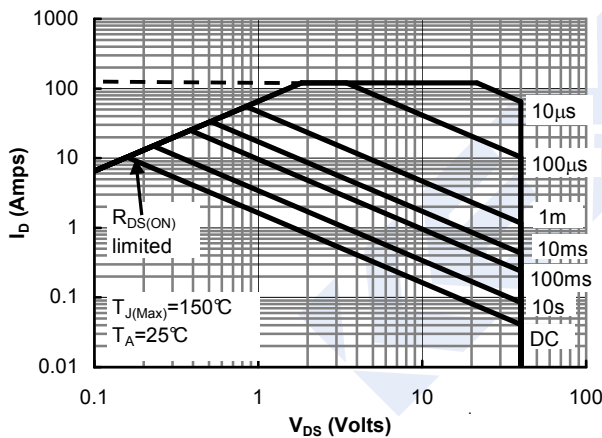


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

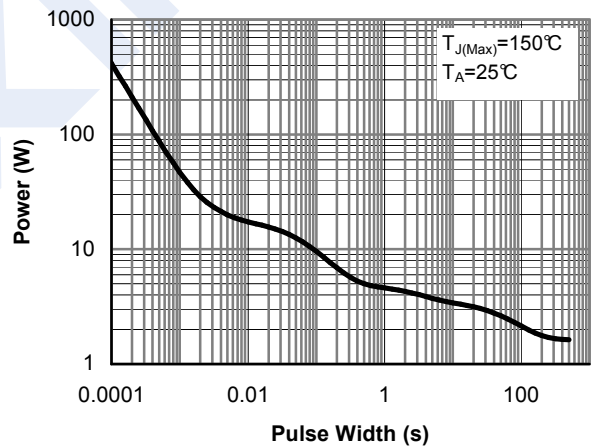


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

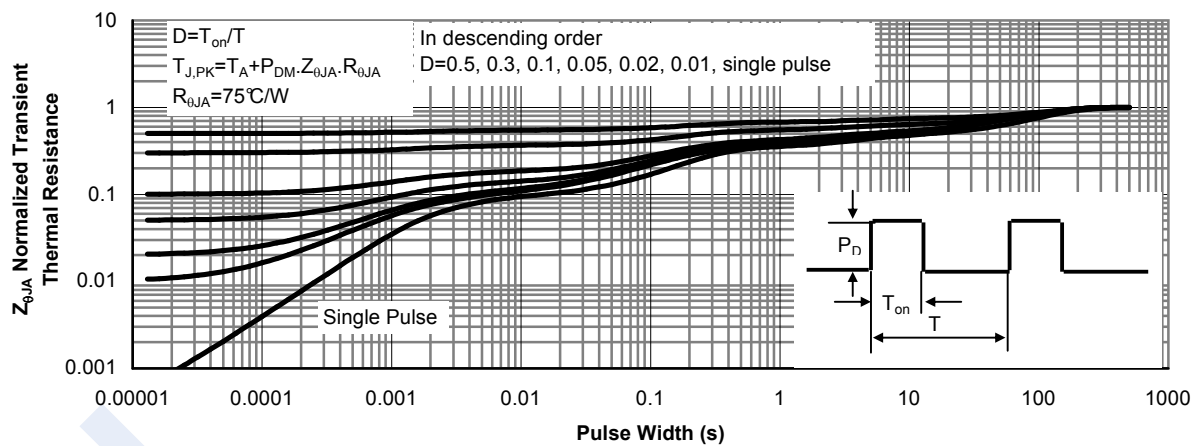


Figure 11: Normalized Maximum Transient Thermal Impedance (Note E)